



# PBSS5540X

40 V, 5 A PNP low  $V_{CEsat}$  (BISS) transistor

15 April 2020

Product data sheet

## 1. General description

PNP low  $V_{CEsat}$  transistor in a medium power SOT89 (SC-62) package.

NPN complement: PBSS4540X.

## 2. Features and benefits

- Low collector-emitter saturation voltage  $V_{CEsat}$
- High collector current capability:  $I_C$  and  $I_{CM}$
- High efficiency leading to less heat generation.
- AEC-Q101 qualified

## 3. Applications

- Supply line switching circuits
- Battery management applications
- DC/DC converter applications
- Strobe flash units
- Medium power driver (e.g. relays, buzzers and motors).

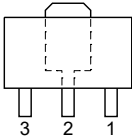
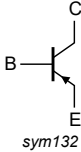
## 4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$V_{CEO}$	collector-emitter voltage	open base	-	-	-40	V
$I_C$	collector current		-	-	-4	A
$I_{CM}$	peak collector current	single pulse; $t_p \leq 10$ ms	-	-	-10	A
$R_{CEsat}$	collector-emitter saturation resistance	$I_C = -5$ A; $I_B = -500$ mA; $t_p \leq 300$ $\mu$ s; pulsed; $\delta \leq 0.02$ ; $T_{amb} = 25$ °C	-	45	75	m $\Omega$

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	E	emitter	 SOT89	 sym132
2	C	collector		
3	B	base		

6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
PBSS5540X	SOT89	plastic, surface-mounted package; 3 leads; 1.5 mm pitch; 4.5 mm x 2.5 mm x 1.5 mm body	SOT89

7. Marking

Table 4. Marking codes

Type number	Marking code[1]
PBSS5540X	%1G

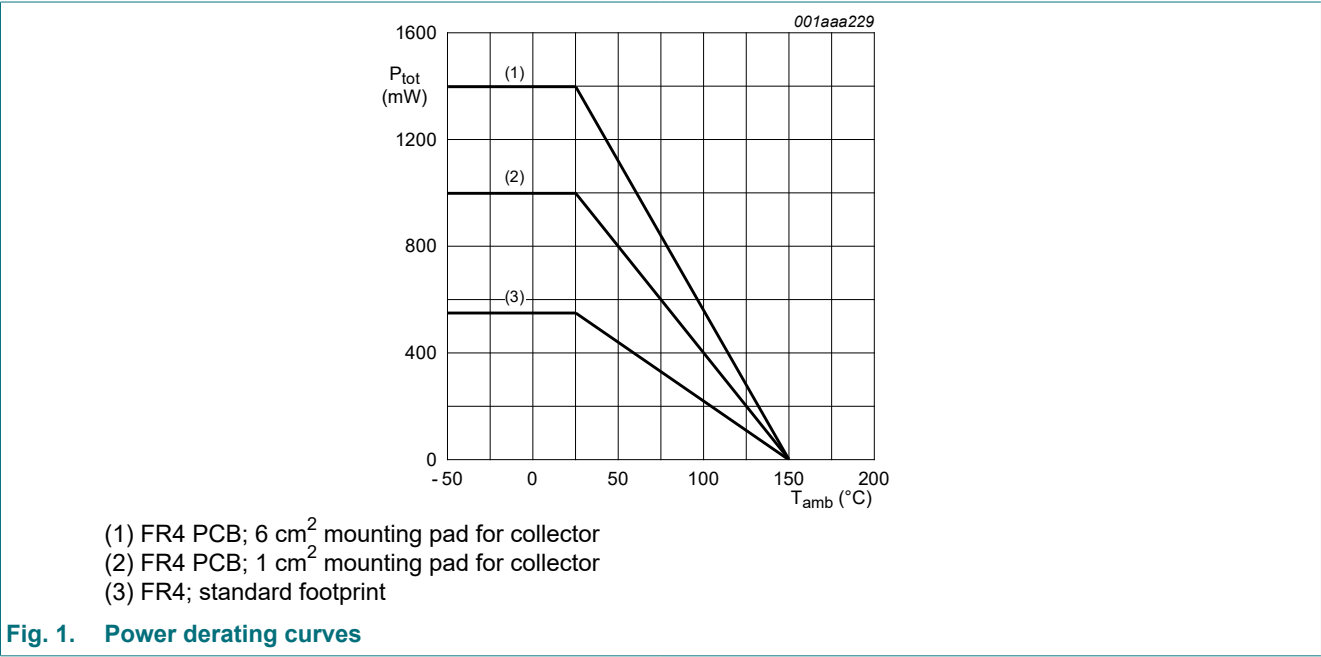
[1] % = placeholder for manufacturing site code

8. Limiting values

Table 5. Limiting values  
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>CBO</sub>	collector-base voltage	open emitter		-	-40	V
V <sub>CEO</sub>	collector-emitter voltage	open base		-	-40	V
V <sub>EBO</sub>	emitter-base voltage	open collector		-	-6	V
I <sub>C</sub>	collector current			-	-4	A
I <sub>CRM</sub>	repetitive peak collector current	$\delta \leq 0.2$ ; $t_p \leq 10$ ms		-	-5	A
I <sub>CM</sub>	peak collector current	single pulse; $t_p \leq 10$ ms		-	-10	A
I <sub>B</sub>	base current			-	-1	A
I <sub>BM</sub>	peak base current	single pulse; $t_p \leq 1$ ms		-	-2	A
P <sub>tot</sub>	total power dissipation		[1] [2]	-	2.5	W
		T <sub>amb</sub> ≤ 25 °C	[2]	-	0.55	W
			[3]	-	1	W
			[4]	-	1.4	W
			[5]	-	1.6	W
T <sub>j</sub>	junction temperature			-	150	°C
T <sub>amb</sub>	ambient temperature			-65	150	°C
T <sub>stg</sub>	storage temperature			-65	150	°C

- [1] Pulsed  $t_p \leq 10$  ms;  $\delta \leq 0.2$
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 1 cm<sup>2</sup>.
- [4] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 6 cm<sup>2</sup>.
- [5] Device mounted on a 7 cm<sup>2</sup> ceramic printed-circuit board, 1 cm<sup>2</sup> single-sided copper and tin-plated.

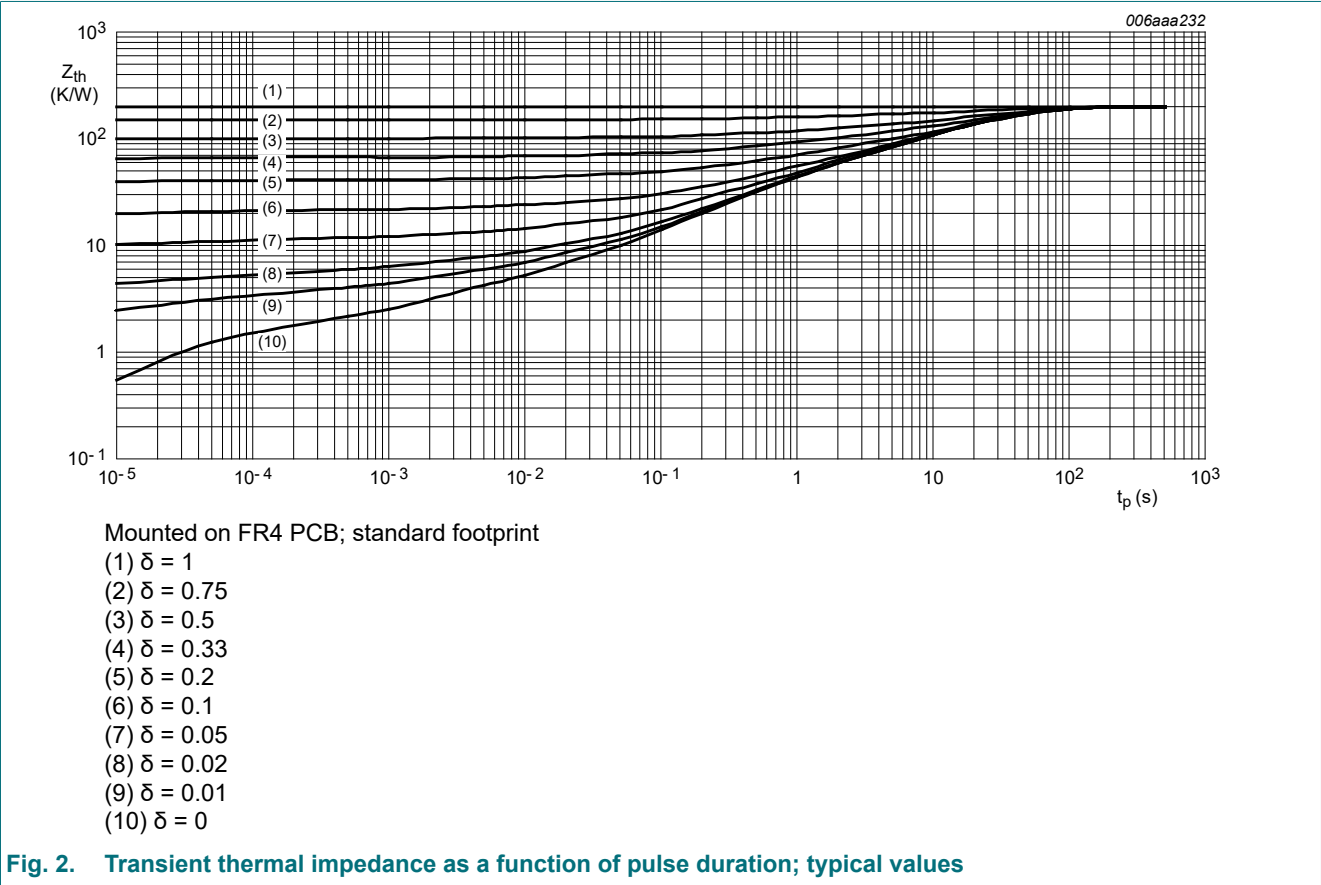


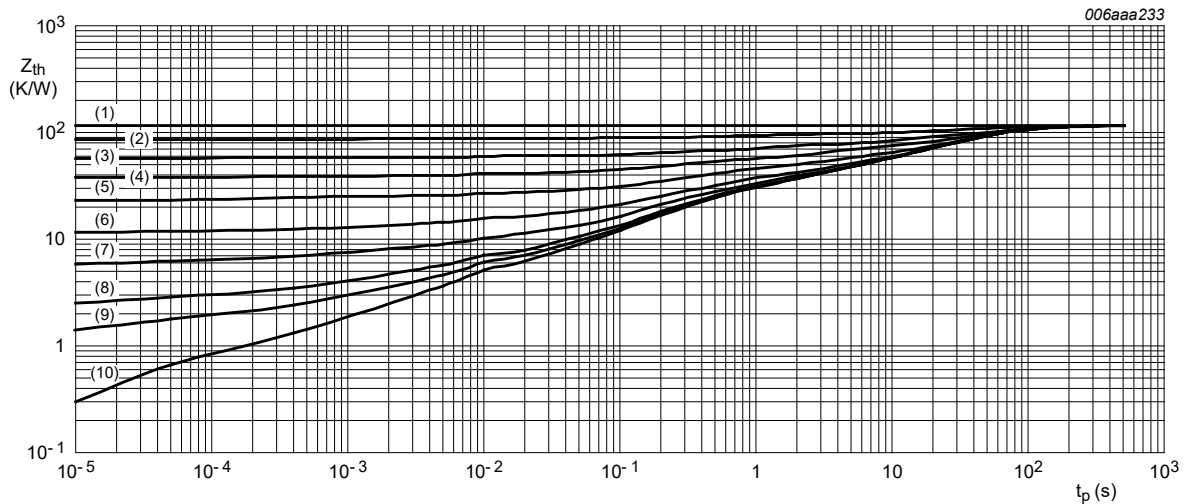
9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	in free air	[1] [2]	-	-	50	K/W
			[1]	-	-	225	K/W
			[3]	-	-	125	K/W
			[4]	-	-	90	K/W
			[5]	-	-	80	K/W
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point			-	-	16	K/W

- [1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [2] Pulse test: t<sub>p</sub> ≤ 10 ms; δ ≤ 0.2.
- [3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 1 cm<sup>2</sup>.
- [4] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 6 cm<sup>2</sup>.
- [5] Device mounted on a 7 cm<sup>2</sup> ceramic printed-circuit board, 1 cm<sup>2</sup> single-sided copper and tin-plated.

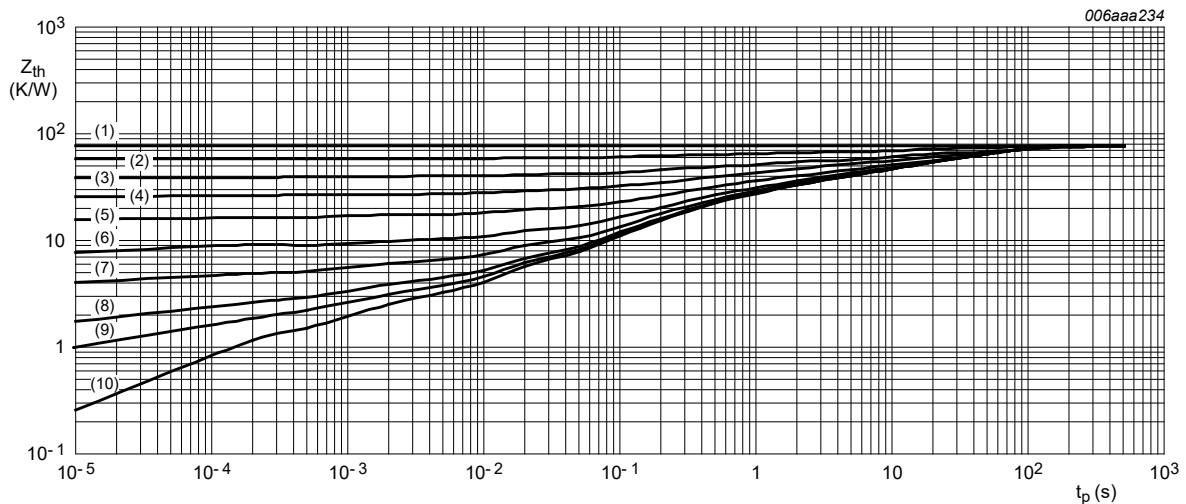




Mounted on FR4 PCB; mounting pad for collector  $1\text{ cm}^2$

- (1)  $\delta = 1$
- (2)  $\delta = 0.75$
- (3)  $\delta = 0.5$
- (4)  $\delta = 0.33$
- (5)  $\delta = 0.2$
- (6)  $\delta = 0.1$
- (7)  $\delta = 0.05$
- (8)  $\delta = 0.02$
- (9)  $\delta = 0.01$
- (10)  $\delta = 0$

**Fig. 3. Transient thermal impedance as a function of pulse duration; typical values**



Mounted on FR4 printed-circuit board; mounting pad for collector  $6\text{ cm}^2$

- (1)  $\delta = 1$
- (2)  $\delta = 0.75$
- (3)  $\delta = 0.5$
- (4)  $\delta = 0.33$
- (5)  $\delta = 0.2$
- (6)  $\delta = 0.1$
- (7)  $\delta = 0.05$
- (8)  $\delta = 0.02$
- (9)  $\delta = 0.01$
- (10)  $\delta = 0$

**Fig. 4. Transient thermal impedance as a function of pulse duration; typical values**

## 10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$I_{CBO}$	collector-base cut-off current	$V_{CB} = -30\text{ V}; I_E = 0\text{ A}; T_{amb} = 25\text{ }^{\circ}\text{C}$	-	-	-100	nA
		$V_{CB} = -30\text{ V}; I_E = 0\text{ A}; T_j = 150\text{ }^{\circ}\text{C}$	-	-	-50	$\mu\text{A}$
$I_{EBO}$	emitter-base cut-off current	$V_{EB} = -5\text{ V}; I_C = 0\text{ A}; T_{amb} = 25\text{ }^{\circ}\text{C}$	-	-	-100	nA
$h_{FE}$	DC current gain	$V_{CE} = -2\text{ V}; I_C = -0.5\text{ A}; T_{amb} = 25\text{ }^{\circ}\text{C}$	250	-	-	
		$V_{CE} = -2\text{ V}; I_C = -1\text{ A}; t_p \leq 300\text{ }\mu\text{s};$ pulsed; $\delta \leq 0.02; T_{amb} = 25\text{ }^{\circ}\text{C}$	200	-	-	
		$V_{CE} = -2\text{ V}; I_C = -2\text{ A}; t_p \leq 300\text{ }\mu\text{s};$ pulsed; $\delta \leq 0.02; T_{amb} = 25\text{ }^{\circ}\text{C}$	150	-	-	
		$V_{CE} = -2\text{ V}; I_C = -5\text{ A}; t_p \leq 300\text{ }\mu\text{s};$ pulsed; $\delta \leq 0.02; T_{amb} = 25\text{ }^{\circ}\text{C}$	50	-	-	
$V_{CEsat}$	collector-emitter saturation voltage	$I_C = -0.5\text{ A}; I_B = -5\text{ mA}; T_{amb} = 25\text{ }^{\circ}\text{C}$	-	-	-120	mV
		$I_C = -1\text{ A}; I_B = -10\text{ mA}; T_{amb} = 25\text{ }^{\circ}\text{C}$	-	-	-170	mV
		$I_C = -2\text{ A}; I_B = -200\text{ mA}; T_{amb} = 25\text{ }^{\circ}\text{C}$	-	-	-160	mV
		$I_C = -4\text{ A}; I_B = -200\text{ mA}; t_p \leq 300\text{ }\mu\text{s};$ pulsed; $\delta \leq 0.02; T_{amb} = 25\text{ }^{\circ}\text{C}$	-	-	-340	mV
		$I_C = -5\text{ A}; I_B = -500\text{ mA}; t_p \leq 300\text{ }\mu\text{s};$ pulsed; $\delta \leq 0.02; T_{amb} = 25\text{ }^{\circ}\text{C}$	-	-	-375	mV
$R_{CEsat}$	collector-emitter saturation resistance		-	45	75	m $\Omega$
$V_{BEsat}$	base-emitter saturation voltage	$I_C = -4\text{ A}; I_B = -200\text{ mA}; t_p \leq 300\text{ }\mu\text{s};$ pulsed; $\delta \leq 0.02; T_{amb} = 25\text{ }^{\circ}\text{C}$	-	-	-1.1	V
		$I_C = -5\text{ A}; I_B = -500\text{ mA}; t_p \leq 300\text{ }\mu\text{s};$ pulsed; $\delta \leq 0.02; T_{amb} = 25\text{ }^{\circ}\text{C}$	-	-	-1.2	V
$V_{BEon}$	base-emitter turn-on voltage	$V_{CE} = -2\text{ V}; I_C = -2\text{ A}; T_{amb} = 25\text{ }^{\circ}\text{C}$	-	-	-1	V
$f_T$	transition frequency	$V_{CE} = -10\text{ V}; I_C = -0.1\text{ A}; f = 100\text{ MHz};$ $T_{amb} = 25\text{ }^{\circ}\text{C}$	60	-	-	MHz
$C_c$	collector capacitance	$V_{CB} = -10\text{ V}; I_E = 0\text{ A}; i_e = 0\text{ A};$ $f = 1\text{ MHz}; T_{amb} = 25\text{ }^{\circ}\text{C}$	-	-	105	pF

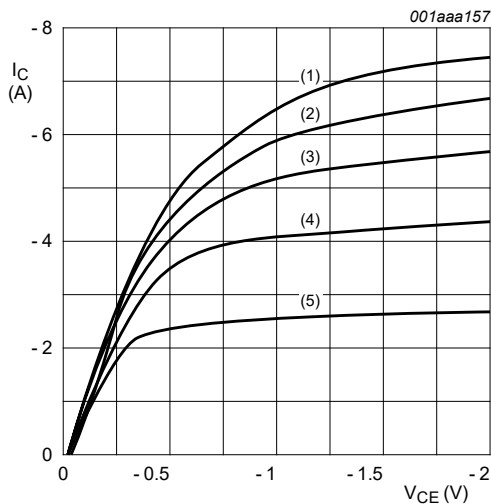


Fig. 5. Collector current as a function of collector-emitter voltage; typical values

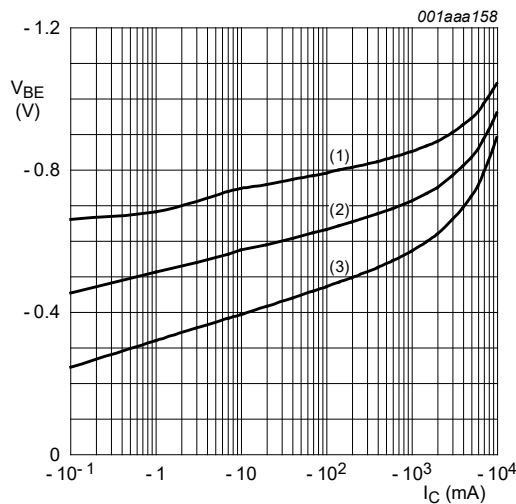


Fig. 6. Base-emitter voltage as a function of collector current; typical values

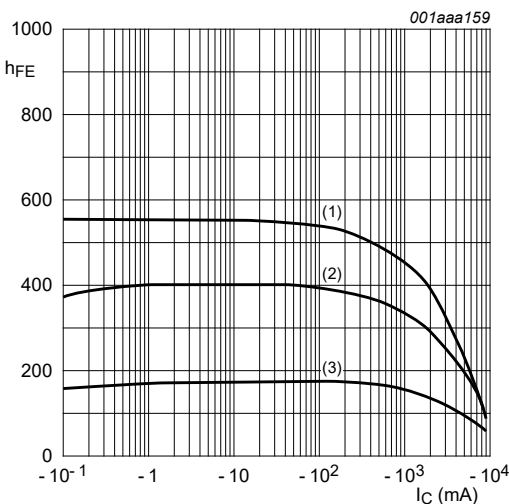


Fig. 7. DC current gain as a function of collector current; typical values

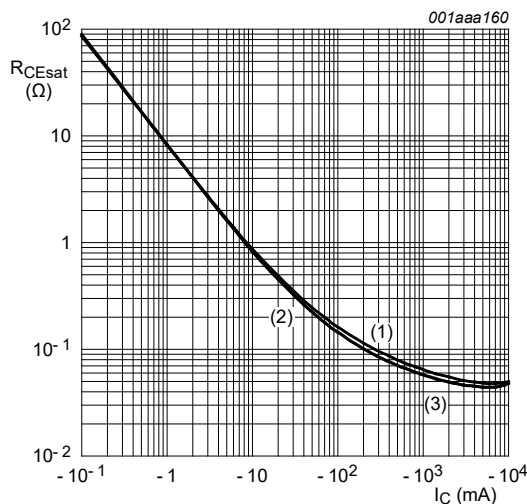


Fig. 8. Equivalent on-resistance as a function of collector current; typical values

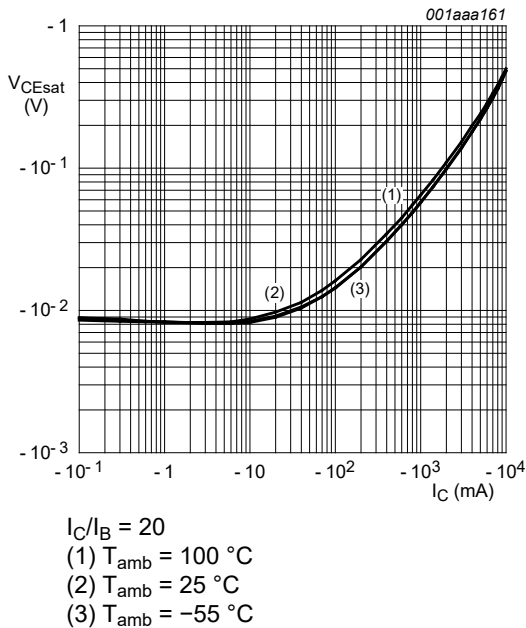


Fig. 9. Collector-emitter saturation voltage as a function of collector current; typical values

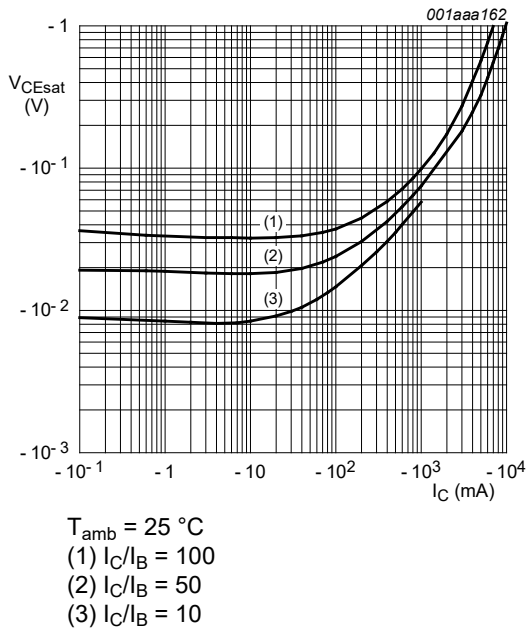


Fig. 10. Collector-emitter saturation voltage as a function of collector current; typical values

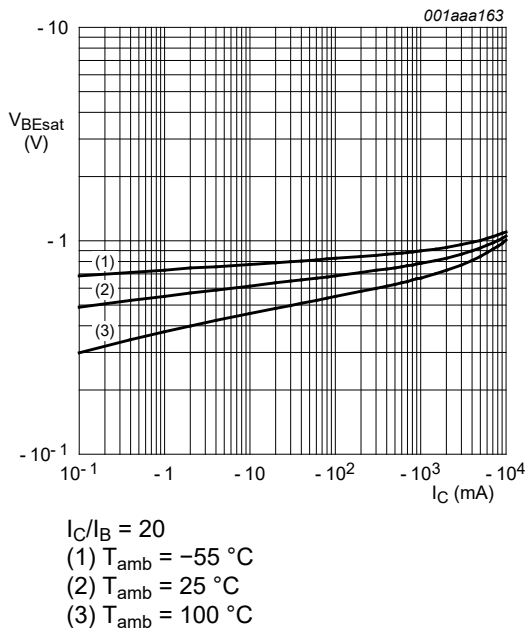


Fig. 11. Base-emitter saturation voltage as a function of collector current; typical values

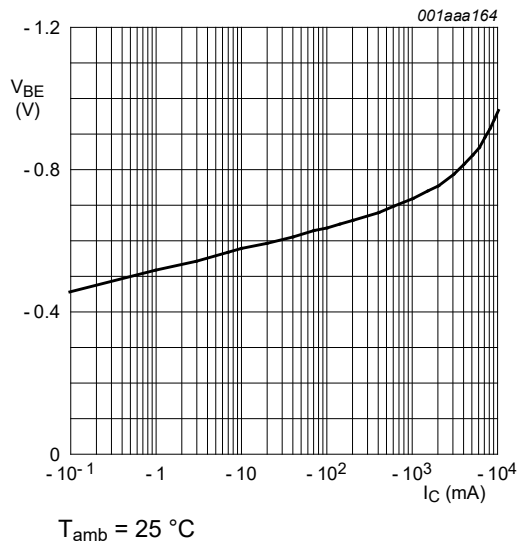
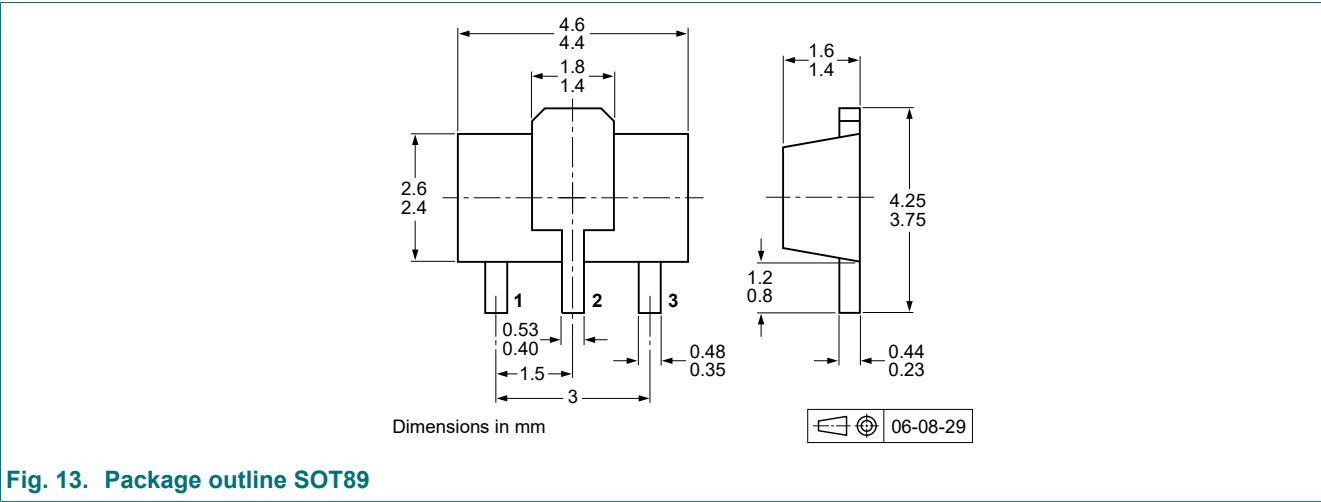


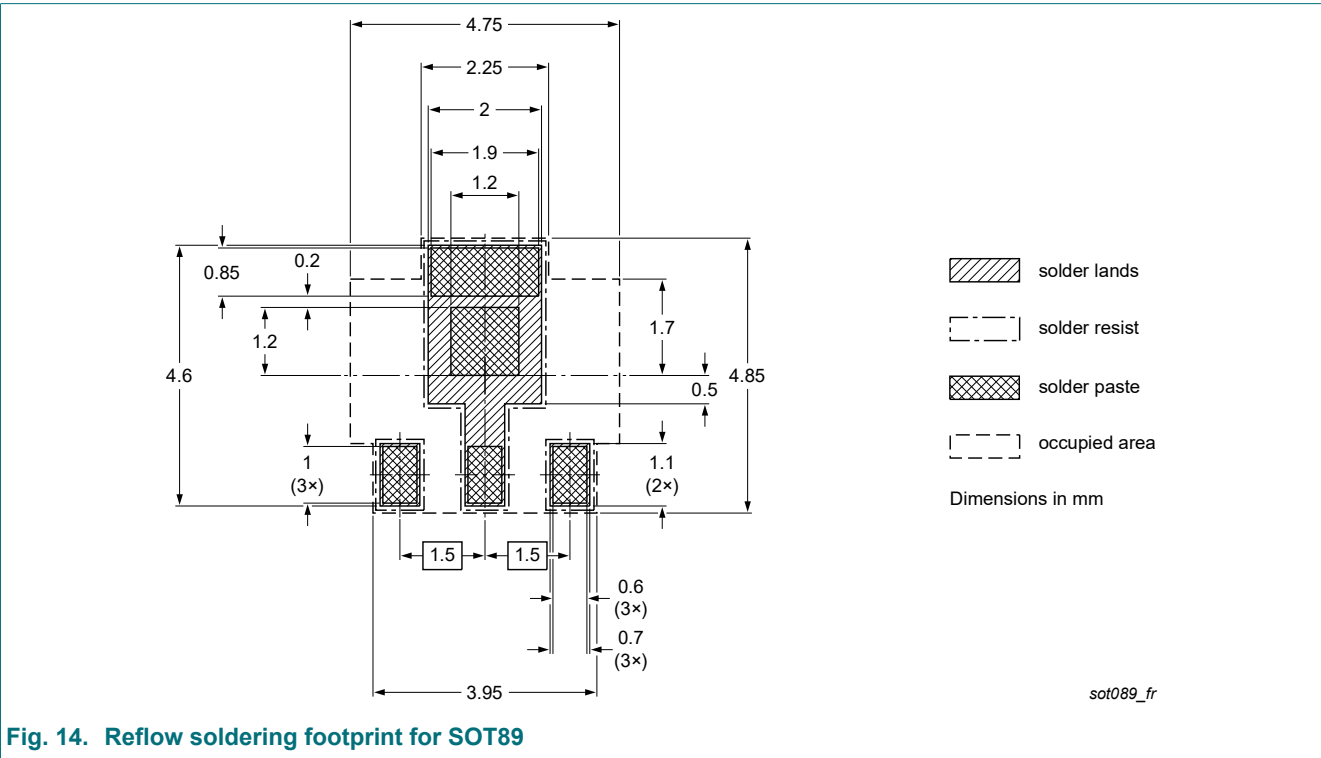
Fig. 12. Base-emitter voltage as a function of collector current; typical values

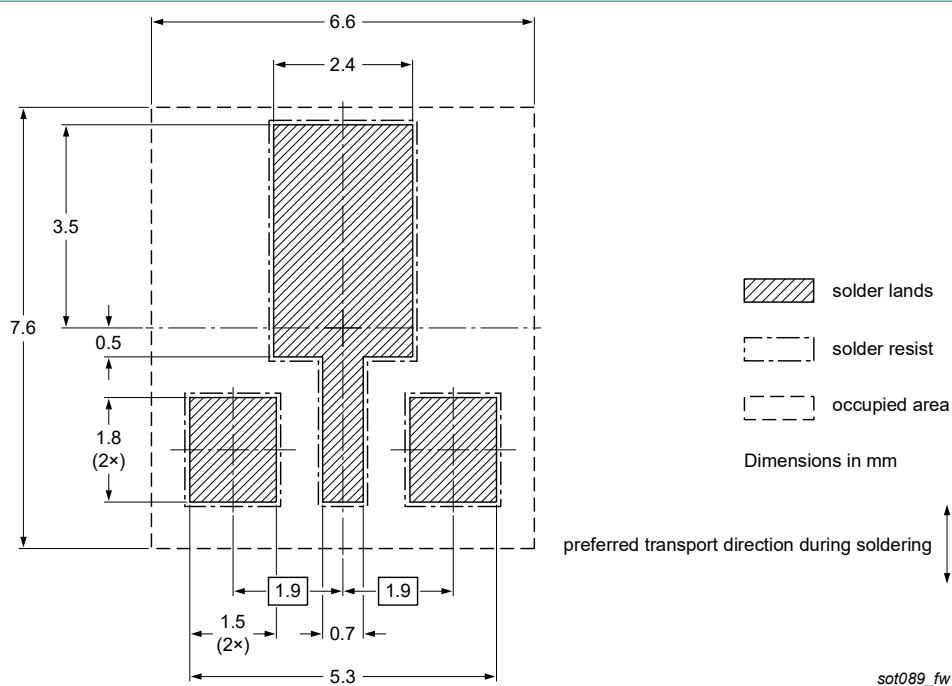


11. Package outline



12. Soldering





**Fig. 15. Wave soldering footprint for SOT89**

13. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PBSS5540X v.4	20200415	Product data sheet	-	PBSS5540X v.3
Modifications:	• Limiting values at I <sub>CM</sub> : conditions corrected			
PBSS5540X v.3	20180320	Product data sheet	-	PBSS5540X v.2
PBSS5540X v.2	20041104	Product data sheet	-	PBSS5540X v.1
PBSS5540X v.1	20040115	Product data sheet	-	-

## 14. Legal information

### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions".
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Date of release: 15 April 2020

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